

# 8 Pin DIP Dual Fast Logic TTL Compatible Active Delay Lines EPA509-XX & EPA509-XX-LF

Add "-LF" after part number for Lead-Free

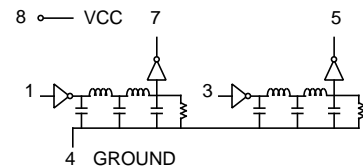
PCA Part Number	Delay Time *	PCA Part Number	Delay Time *	PCA Part Number	Delay Time *
EPA509-5(-LF)	5 ± 1	EPA509-18(-LF)	18	EPA509-55(-LF)	55
EPA509-6(-LF)	6 ± 1	EPA509-19(-LF)	19	EPA509-60(-LF)	60
EPA509-7(-LF)	7 ± 1	EPA509-20(-LF)	20	EPA509-65(-LF)	65
EPA509-8(-LF)	8 ± 1	EPA509-21(-LF)	21	EPA509-70(-LF)	70
EPA509-9(-LF)	9 ± 1	EPA509-22(-LF)	22	EPA509-75(-LF)	75
EPA509-10(-LF)	10 ± 1.5	EPA509-23(-LF)	23	EPA509-80(-LF)	80
EPA509-11(-LF)	11 ± 1.5	EPA509-24(-LF)	24	EPA509-85(-LF)	85
EPA509-12(-LF)	12 ± 1.5	EPA509-25(-LF)	25	EPA509-90(-LF)	90
EPA509-13(-LF)	13 ± 1.5	EPA509-30(-LF)	30	EPA509-95(-LF)	95
EPA509-14(-LF)	14 ± 1.5	EPA509-35(-LF)	35	EPA509-100(-LF)	100
EPA509-15(-LF)	15	EPA509-40(-LF)	40	EPA509-150(-LF)	150
EPA509-16(-LF)	16	EPA509-45(-LF)	45	EPA509-200(-LF)	200
EPA509-17(-LF)	17	EPA509-50(-LF)	50	EPA509-250(-LF)	250

Delay Times referenced from input to leading edges at 25°C, 5.0V, with no load.

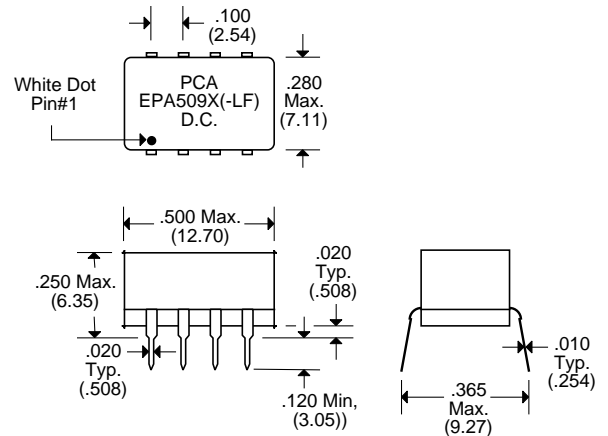
\* Unless otherwise specified, delay tolerance is ± 2 nS or ± 5%, whichever is greater.

DC Electrical Characteristics Parameter	Test Conditions	Min.	Max.	Unit
V <sub>OH</sub>	High-Level Output Voltage	V <sub>CC</sub> = min. V <sub>IL</sub> = max. I <sub>OH</sub> = max	2.7	V
V <sub>OL</sub>	Low-Level Output Voltage	V <sub>CC</sub> = min. V <sub>IH</sub> = min. I <sub>OL</sub> = max	0.5	V
V <sub>IK</sub>	Input Clamp Voltage	V <sub>CC</sub> = min. I <sub>I</sub> = I <sub>IK</sub>	-1.2	V
I <sub>IH</sub>	High-Level Input Current	V <sub>CC</sub> = max. V <sub>IN</sub> = 2.7V	50	µA
		V <sub>CC</sub> = max. V <sub>IN</sub> = 5.25V	1.0	mA
I <sub>IL</sub>	Low-Level Input Current	V <sub>CC</sub> = max. V <sub>IN</sub> = 0.5V	-2	mA
I <sub>OS</sub>	Short Circuit Output Current	V <sub>CC</sub> = max. V <sub>OUT</sub> = 0.	-40	mA
		(One output at a time)		
I <sub>CCH</sub>	High-Level Supply Current	V <sub>CC</sub> = max. V <sub>IN</sub> = OPEN	90	mA
I <sub>CCL</sub>	Low-Level Supply Current	V <sub>CC</sub> = max. V <sub>IN</sub> = 0	90	mA
T <sub>RO</sub>	Output Rise Time	T <sub>d</sub> ≤ 500 nS (0.75 to 2.4 Volts)	4	nS
N <sub>H</sub>	Fanout High-Level Output	V <sub>CC</sub> = max. V <sub>OH</sub> = 2.7V	20 TTL Load	
N <sub>L</sub>	Fanout Low-Level Output	V <sub>CC</sub> = max. V <sub>OL</sub> = 0.5V	10 TTL Load	

### Schematic



### Package



Recommended Operating Conditions	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage	4.75	5.25	V
V <sub>IH</sub>	High-Level Input Voltage	2.0		V
V <sub>IL</sub>	Low-Level Input Voltage		0.8	V
I <sub>IK</sub>	Input Clamp Current		-18	mA
I <sub>OH</sub>	High-Level Output Current		-1.0	mA
I <sub>OL</sub>	Low-Level Output Current		20	mA
PW*	Pulse Width of Total Delay	40		%
d*	Duty Cycle		40	%
T <sub>A</sub>	Operating Free-Air Temperature	0	+70	°C

\*These two values are inter-dependent.

Input Pulse Test Conditions @ 25° C	Unit	
E <sub>IN</sub>	Pulse Input Voltage	3.2 Volts
PW	Pulse Width % of Total Delay	110 %
T <sub>RI</sub>	Pulse Rise Time (0.75 - 2.4 Volts)	2.0 nS
PRR	Pulse Repetition Rate	1.0 MHz
V <sub>CC</sub>	Supply Voltage	5.0 Volts

Notes :	EPA509-XX	EPA509-XX-LF
1. Lead Finish	SnPb	Hot Tin Dip (Sn)
2. Peak Solder Rating (Wave Solder Process)	260°C 10 (+2/-0) seconds	260°C 10 (+2/-0) seconds
4. Weight	TBD grams	TBD grams
5. Packaging Information (Tube)	TBD pieces/tube	TBD pieces/tube

Unless Otherwise Specified Dimensions are in Inches /mm ± .010 / .25